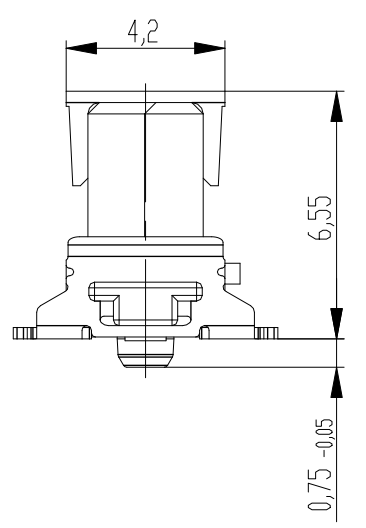
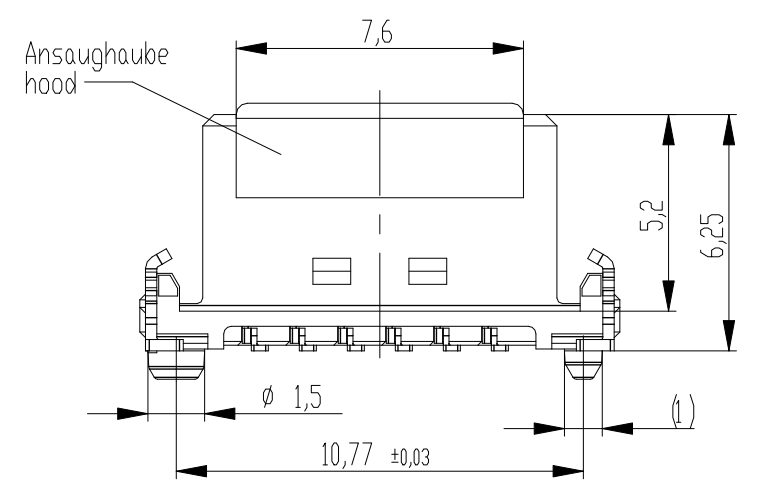
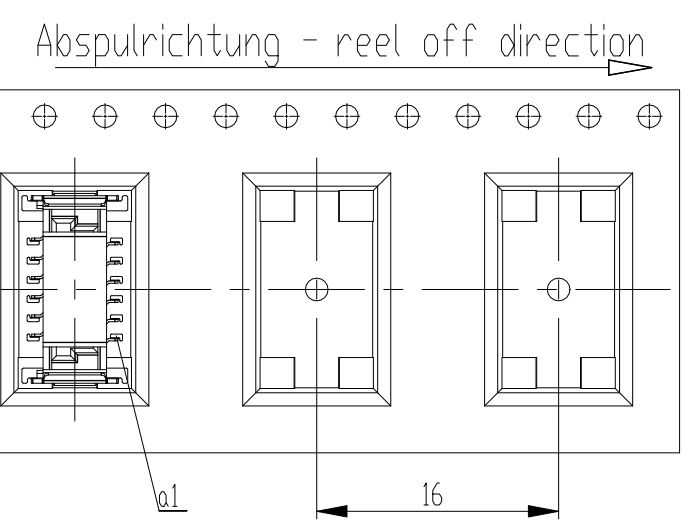
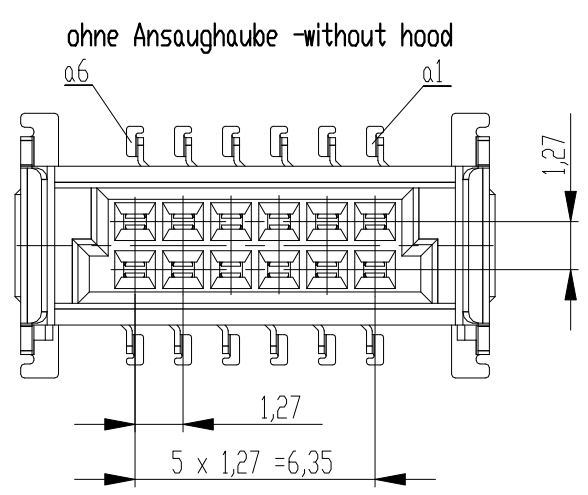
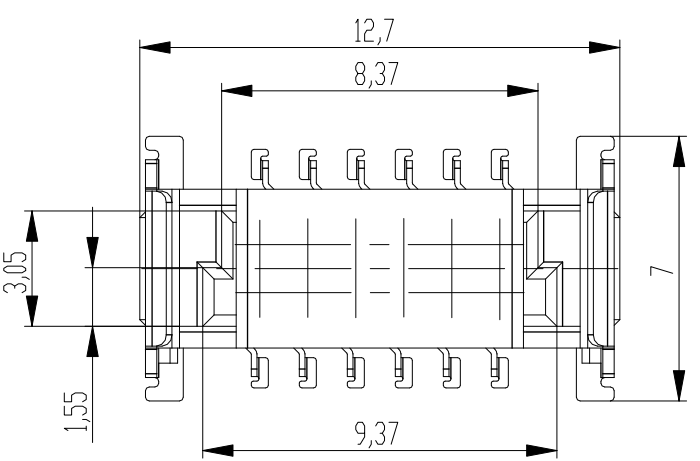
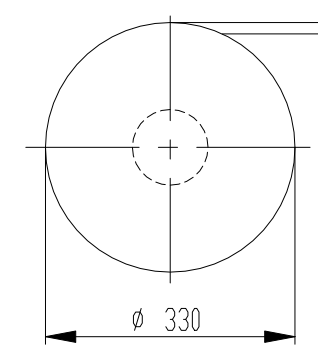


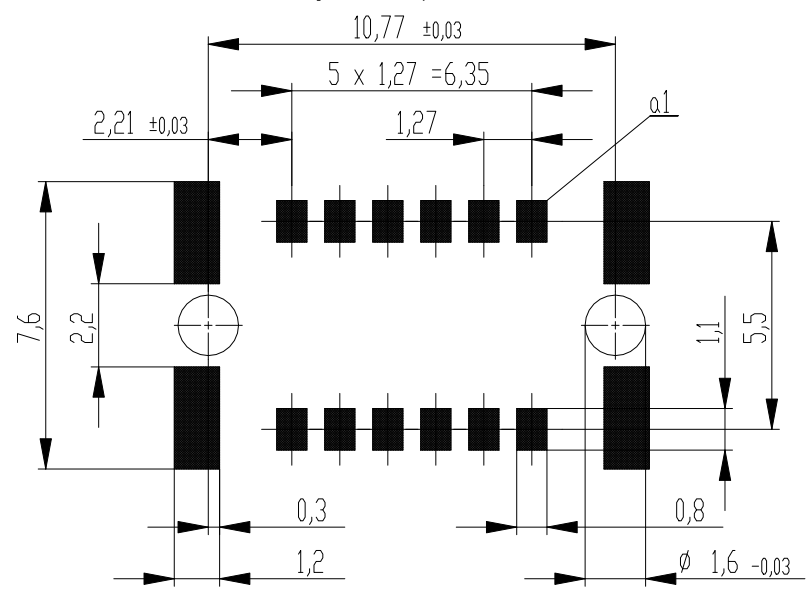
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Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
tape on reel packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
packaging unit: 280 pcs

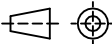


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Anforderungsstufe 1
performance level 1
Kontaktbereich vergoldet
mating area gold plating
Anschlussbereich verzinkt 4-6 µm
terminal area 4-6 µm tin plating
Koplanarität der Anschlüsse ≤ 0,1 mm
coplanarity area of termination ≤ 0,1 mm

BA 7-13 - 8mm Bauhöhe
type7-13 - low profile

Dimension no.				Tolerances Dim. for Information ISO 8015		 All Dimensions in mm	Scale 5:1		Material	
<u>Customer drawing:</u> THIS DRAWING IS A CONTROLLED DOCUMENT.				Subject to modification without prior notice. Drawing will not be updated.			ERNI-Federl. SMC-B 12-SMD-BA7-13 Female SMC-B 12-SMD-type7-13			
				f		28.05.2021		 TE Connectivity		©=154805-E
Index		Date		Class			SMCB			A3